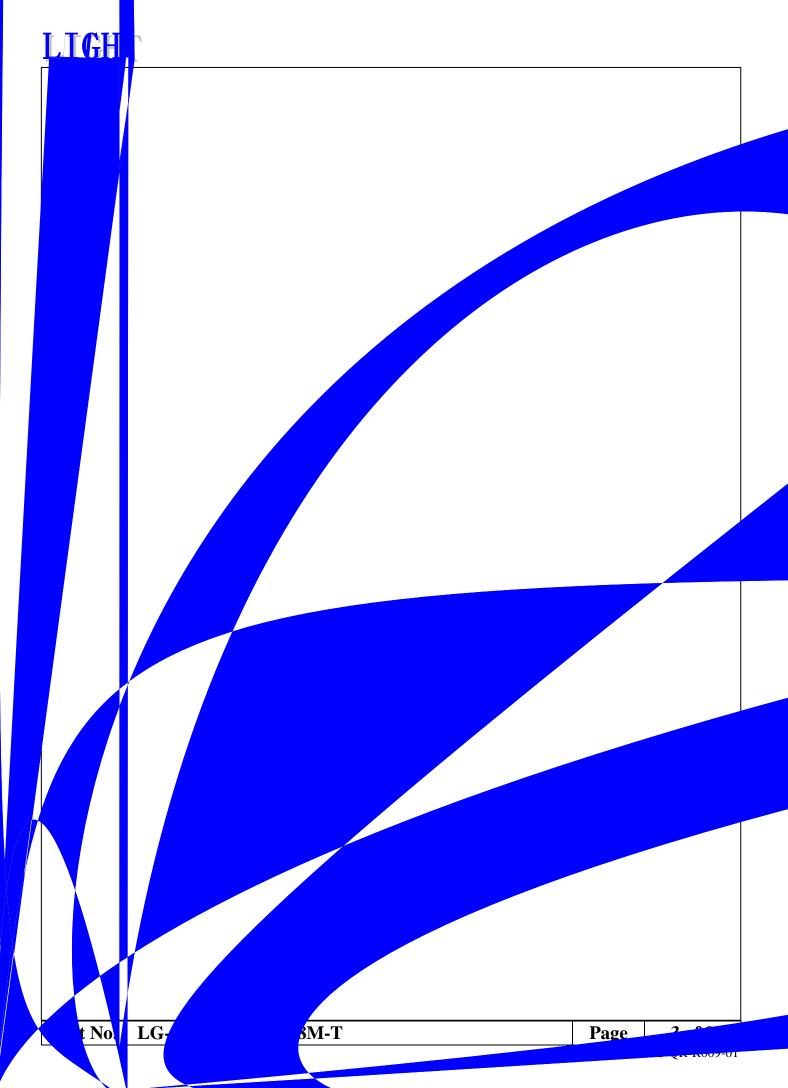




Features

- Pb free product RoHS compliant
- Low power consumption, High efficiency
- General purpose leads
- Reliable and rugged
- ♦ Long life

Part No.	LG-05IR4T94C-5118M-T	Page	2 of 9



296.4Arri1 2117513662 7956.213mm 0.4 of mini 02(mum 0.4 c 0 lea)20(T)61nJ /e/ / fTopJom the /Pnati4en-US





Electrical Optical Characteristics at Ta=25°C 0--- JTETQ EMC /P AMCID 6//Lang (en-US) BDC q287.29 68ET7.

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Radiant Intensity	Ie	10.5	14.0	18.5	mW/sr	I _F =50mA (Note 1,3)

Viewing Angle

Part No. LG-05IR4T94C-5118M-T	Page	4 of 9
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Infrared Emitting Diode Specification

•Commodity: Infrared emitting diode

●Intensity Bin Limits (At 50mA)

BIN CODE	Min.(mW/sr)	Max.(mW/sr)
27	10.5	14.0
28	14.0	18.5

Part No.	LG-05IR4T94C-5118M-T	Page	5 of 9

Typical Electrical / Optical Characteristics Curves (25







LEAD FORMING PROCEDURES

1. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend (Fig.5 and Fig.6).

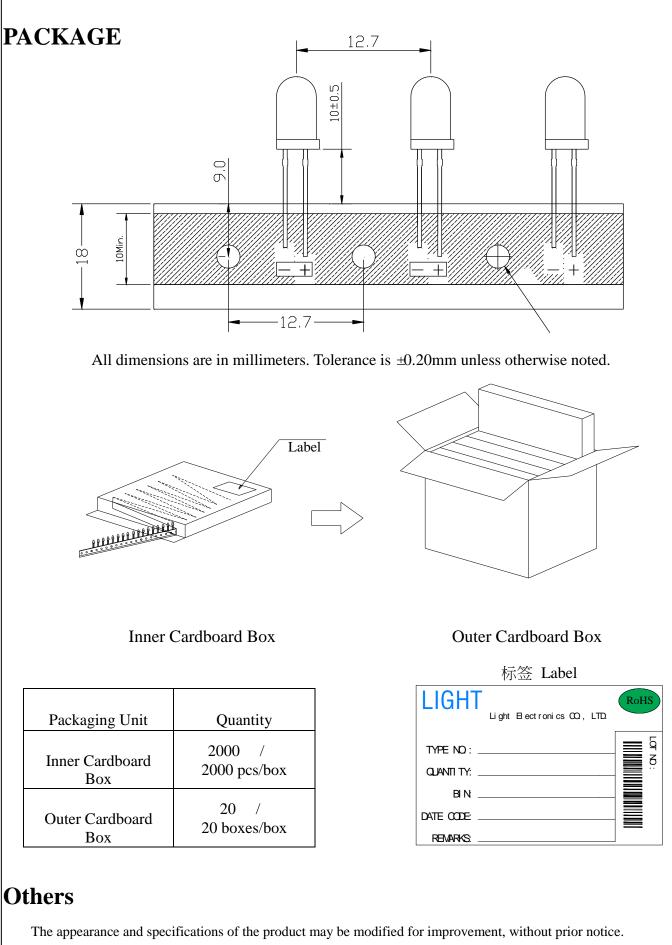
2. Lead forming or bending must be performed before soldering, never during or after soldering.

3. Do not stress the LED lens during lead-forming in order to fractures in the lens epoxy and damage the internal structures.

4. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead

Part No.	LG-05IR4T94C-5118M-T	Page	8 of 9





Part No.	LG-05IR4T94C-5118M-T	Page	9 of 9
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